## onsemi

## Undervoltage Sensing Circuit

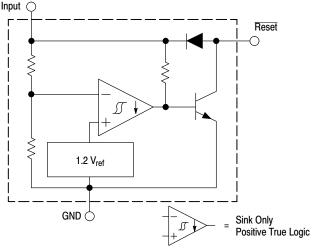
### MC34064, MC33064, NCV33064

The MC34064 is an undervoltage sensing circuit specifically designed for use as a reset controller in microprocessor-based systems. It offers the designer an economical solution for low voltage detection with a single external resistor. The MC34064 features a trimmed-in-package bandgap reference, and a comparator with precise thresholds and built-in hysteresis to prevent erratic reset operation. The open collector reset output is capable of sinking in excess of 10 mA, and operation is guaranteed down to 1.0 V input with low standby current. The MC devices are packaged in 3-pin TO-92, micro size TSOP-5, 8-pin SOIC-8 and Micro8 surface mount packages. The NCV device is packaged in SOIC-8 and TO-92.

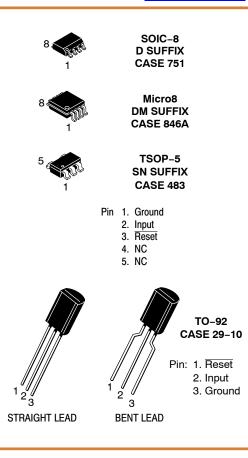
Applications include direct monitoring of the 5.0 V MPU/logic power supply used in appliance, automotive, consumer and industrial equipment.

#### Features

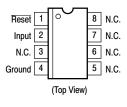
- Trimmed-In-Package Temperature Compensated Reference
- Comparator Threshold of 4.6 V at 25°C
- Precise Comparator Thresholds Guaranteed Over Temperature
- Comparator Hysteresis Prevents Erratic Reset
- Reset Output Capable of Sinking in Excess of 10 mA
- Internal Clamp Diode for Discharging Delay Capacitor
- Guaranteed Reset Operation with 1.0 V Input
- Low Standby Current
- Economical TO-92, TSOP-5, SOIC-8 and Micro8 Surface Mount Packages
- NCV Prefix for Automotive and Other Applications Requiring Site and Control Changes
- These Devices are Pb-Free and are RoHS Compliant



This device contains 21 active transistors. Figure 1. Representative Block Diagram







#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 6 of this data sheet.

#### **DEVICE MARKING INFORMATION**

See general marking information in the device marking section on page 7 of this data sheet.

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Power Input Supply Voltage	V <sub>in</sub>	-1.0 to 10	V
Reset Output Voltage	V <sub>O</sub>	10	V
Reset Output Sink Current (Note 2)	I <sub>Sink</sub>	Internally Limited	mA
Clamp Diode Forward Current, Reset to Input Pin (Note 2)	١ <sub>F</sub>	100	mA
Power Dissipation and Thermal Characteristics P Suffix, Plastic Package Maximum Power Dissipation @ $T_A = 25^{\circ}C$ Thermal Resistance, Junction-to-Air D Suffix, Plastic Package Maximum Power Dissipation @ $T_A = 25^{\circ}C$ Thermal Resistance, Junction-to-Air DM Suffix, Plastic Package Maximum Power Dissipation @ $T_A = 25^{\circ}C$ Thermal Resistance, Junction-to-Air	Ρ <sub>D</sub> R <sub>θJA</sub> Ρ <sub>D</sub> R <sub>θJA</sub> Ρ <sub>D</sub> R <sub>θJA</sub>	625 200 625 200 520 240	mW °C/W ™W °C/W mW °C/W
Operating Junction Temperature	Т <sub>Ј</sub>	+150	°C
Operating Ambient Temperature MC34064 MC33064 NCV33064	T <sub>A</sub>	0 to +70 -40 to +85 -40 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	–65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. ESD data available upon request.

**ELECTRICAL CHARACTERISTICS** (For typical values  $T_A = 25^{\circ}$ C, for min/max values  $T_A$  is the operating ambient temperature range that applies [Notes 3 and 4] unless otherwise noted.)

Characteristics	Symbol	Min	Тур	Max	Unit
COMPARATOR		•			
Threshold Voltage High State Output (V <sub>in</sub> Increasing) Low State Output (V <sub>in</sub> Decreasing) Hysteresis	V <sub>IH</sub> VIL V <sub>H</sub>	4.5 4.5 0.01	4.61 4.59 0.02	4.7 4.7 0.05	V
RESET OUTPUT	-				
Output Sink Saturation (V <sub>in</sub> = 4.0 V, I <sub>Sink</sub> = 8.0 mA) (V <sub>in</sub> = 4.0 V, I <sub>Sink</sub> = 2.0 mA) (V <sub>in</sub> = 1.0 V, I <sub>Sink</sub> = 0.1 mA)	V <sub>OL</sub>	- - -	0.46 0.15 -	1.0 0.4 0.1	V
Output Sink Current (V <sub>in</sub> , Reset = 4.0 V)	I <sub>Sink</sub>	10	27	60	mA
Output Off-State Leakage (V <sub>in</sub> , Reset = 5.0 V)	I <sub>OH</sub>	-	0.02	0.5	μA
Clamp Diode Forward Voltage, Reset to Input Pin ( $I_F = 10 \text{ mA}$ )	V <sub>F</sub>	0.6	0.9	1.2	V
TOTAL DEVICE					

Operating Input Voltage Range	V <sub>in</sub>	1.0 to 6.5	-	I	V
Quiescent Input Current (V <sub>in</sub> = 5.0 V)	l <sub>in</sub>	-	390	500	μΑ

2. Maximum package power dissipation limits must be observed.

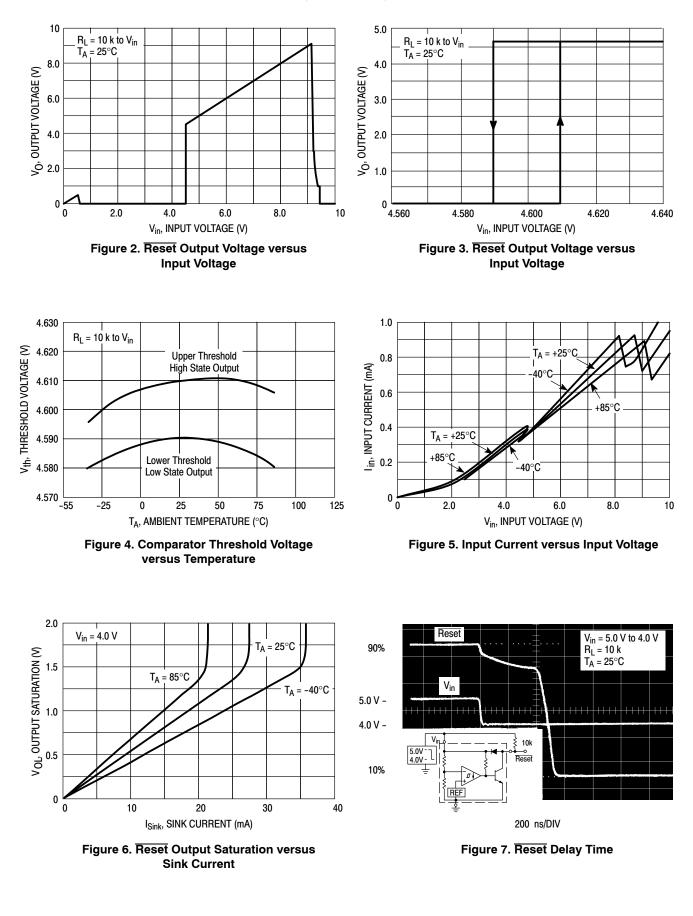
3. Low duty cycle pulse techniques are used during test to maintain junction temperature as close to ambient as possible.

4.  $T_{low} = 0^{\circ}C$  for MC34064  $T_{high} = +70^{\circ}C$  for MC34064

-40°C for MC33064 -40°C for NCV33064

5. NCV prefix is for automotive and other applications requiring site and change control.

<sup>+85°</sup>C for MC33064 +125°C for NCV33064



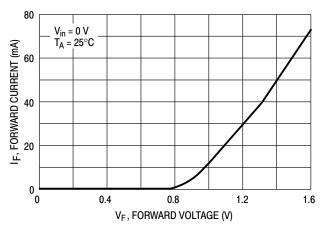


Figure 8. Clamp Diode Forward Current versus Voltage

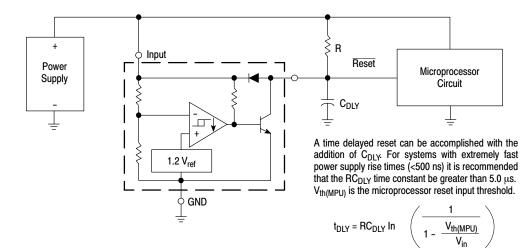
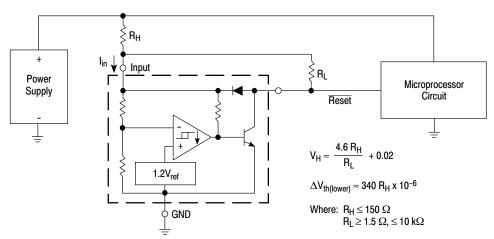


Figure 9. Low Voltage Microprocessor Reset

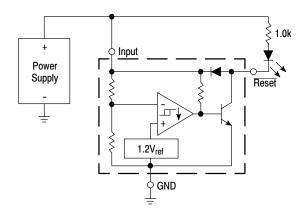


#### **TEST DATA**

V <sub>H</sub> (mV)	∆V <sub>th</sub> (mV)	R <sub>H</sub> (Ω)	R <sub>L</sub> (kΩ)
20	0	0	0
51	3.4	10	1.5
40	6.8	20	4.7
81	6.8	20	1.5
71	10	30	2.7
112	10	30	1.5
100	16	47	2.7
164	16	47	1.5
190	34	100	2.7
327	34	100	1.5
276	51	150	2.7
480	51	150	1.5

Comparator hysteresis can be increased with the addition of resistor  $R_H.$  The hysteresis equation has been simplified and does not account for the change of input current  $I_{in}$  as  $V_{CC}$  crosses the comparator threshold (Figure 4). An increase of the lower threshold  $\Delta V_{th(lower)}$  will be observed due to  $I_{in}$  which is typically 340  $\mu A$  at 4.59 V. The equations are accurate to  $\pm 10\%$  with  $R_H$  less than 150  $\Omega$  and  $R_L$  between 1.5  $k\Omega$  and 10  $k\Omega$ .

#### Figure 10. Low Voltage Microprocessor Reset with Additional Hysteresis



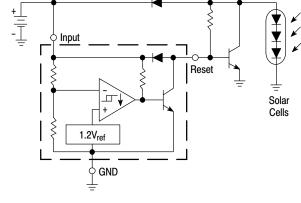




Figure 12. Solar Powered Battery Charger

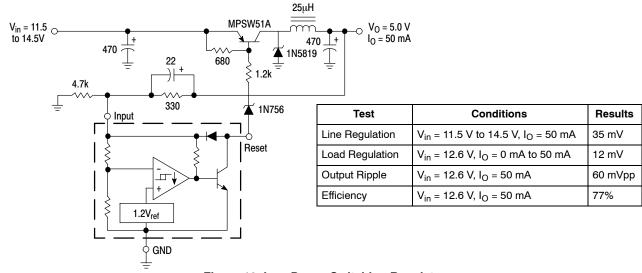
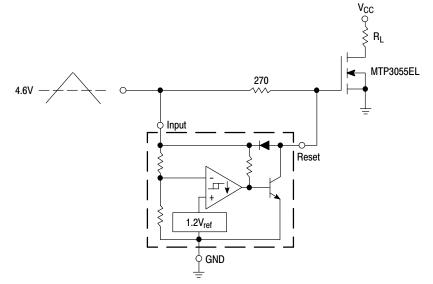


Figure 13. Low Power Switching Regulator



Overheating of the logic level power MOSFET due to insufficient gate voltage can be prevented with the above circuit. When the input signal is below the 4.6 V threshold of the MC34064, its output grounds the gate of the L<sup>2</sup> MOSFET.

#### Figure 14. MOSFET Low Voltage Gate Drive Protection

#### **ORDERING INFORMATION**

Device	<b>Operating Temperature Range</b>	Package	Shipping <sup>†</sup>
MC34064D-5G		SOIC-8 (Pb-Free)	98 Units / Rail
MC34064D-5R2G		SOIC-8 (Pb-Free)	2500 Units/ Tape & Reel
MC34064DM-5R2G		Micro8 (Pb–Free)	4000 Units / Tape & Reel
MC34064P-5G		TO–92 (Pb–Free)	2000 Units / Bag
MC34064P-5RAG	$T_{A} = 0^{\circ}C \text{ to } +70^{\circ}C$	TO–92 (Pb–Free)	2000 Units / Tape & Reel
MC34064P-5RPG	_	TO–92 (Pb–Free)	2000 Units / Ammo Pack
MC34064P-5RMG	_	TO–92 (Pb–Free)	
MC34064SN-5T1G		TSOP–5 (Pb–Free)	3000 Units / Tape & Reel
MC33064D-5G		SOIC–8 (Pb–Free)	98 Units / Rail
MC33064D-5R2G	_	SOIC–8 (Pb–Free)	2500 Units / Tape & Reel
MC33064DM-5R2G		Micro8 (Pb–Free)	4000 Units / Tape & Reel
MC33064P-5G	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	TO–92 (Pb–Free)	2000 Units / Bag
MC33064P-5RAG		TO–92 (Pb–Free)	2000 Units / Tape & Reel
MC33064P-5RPG		TO–92 (Pb–Free)	2000 Units / Ammo Pack
MC33064SN-5T1G		TSOP-5 (Pb-Free)	3000 Units / Tape & Reel
NCV33064D-5R2G*		SOIC-8 (Pb-Free)	2500 Units / Tape & Reel
NCV33064P-5RAG*		TO-92 (Pb-Free)	2000 Units / Tape & Reel
NCV33064P-5RPG*	$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$	TO-92 (Pb-Free)	2000 Units / Ammo Pack
NCV33064DM-5R2G*		Micro8 (Pb–Free)	4000 Units / Tape & Reel

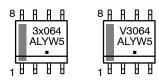
+For information on tape and reel specifications, including part orientation and tape sizes, pleaserefer to our Tape and Reel Packaging Specifications Brobsnit and the specifications and the specification and the specification and the specification of the specification

change control.

#### **MARKING DIAGRAMS**

Micro8

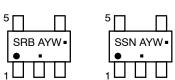
#### SOIC-8 D SUFFIX CASE 751



	8	
Ly50 AYW∎		VI50 AYW∎
-		



TSOP-5 **SN SUFFIX CASE 483** 



MC34064

MC33064

Ξ

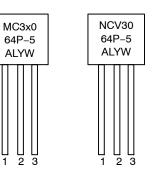
= 3 or 4
= C or I
= Assembly Location
<ul> <li>Wafer Lot</li> </ul>
= Year
<ul> <li>Work Week</li> </ul>
= Pb–Free Package

(Note: Microdot may be in either location)

DM SUFFIX CASE 846A

8

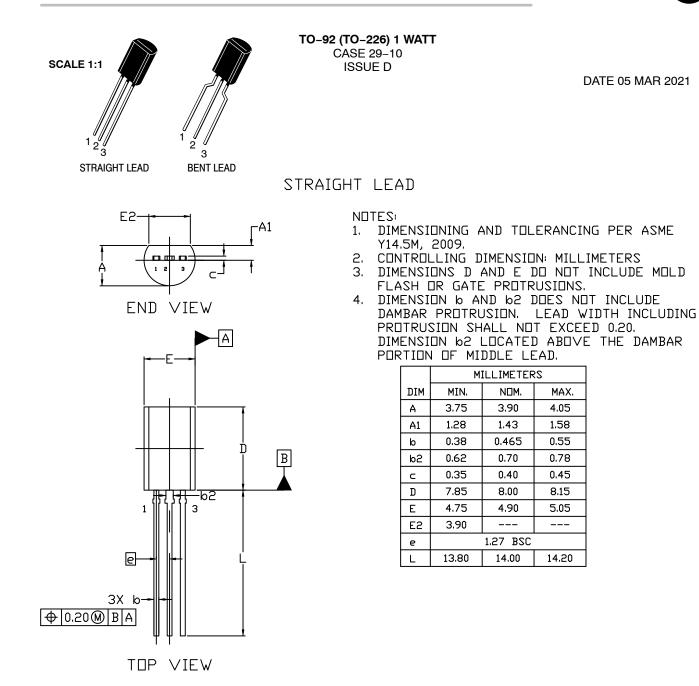




1

#### MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





#### **STYLES AND MARKING ON PAGE 3**

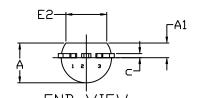
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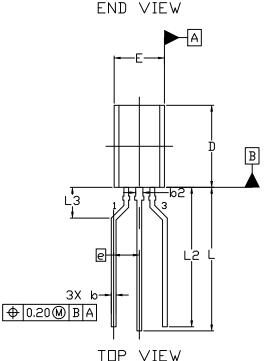


#### **TO-92 (TO-226) 1 WATT** CASE 29–10 ISSUE D

DATE 05 MAR 2021

FORMED LEAD





NDTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS,
- 4. DIMENSION № AND №2 DOES NOT INCLUDE DAMBAR PROTRUSION. LEAD WIDTH INCLUDING PROTRUSION SHALL NOT EXCEED 0.20. DIMENSION №2 LOCATED ABOVE THE DAMBAR PORTION OF MIDDLE LEAD.

	М	ILLIMETER	22	
DIM	MIN.	NDM.	MAX.	
Α	3.75	3.90	4.05	
A1	1.28	1.43	1.58	
σ	0.38	0.465	0.55	
b2	0.62	0.70	0.78	
с	0.35	0.40	0.45	
D	7.85	8.00	8.15	
Е	4.75	4.90	5.05	
E2	3.90			
e		2.50 BSC		
L	13.80	14.00	14.20	
L2	13.20	13.60	14.00	
L3		3.00 REF		

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#### TO-92 (TO-226) 1 WATT CASE 29-10 ISSUE D

#### DATE 05 MAR 2021

STYLE 5: PIN 1. DRAIN

2.	EMITTER BASE COLLECTOR
2.	GATE SOURCE & SUBSTRATE DRAIN
2.	ANODE CATHODE & ANODE CATHODE
2.	ANODE GATE CATHODE
2.	COLLECTOR EMITTER BASE
STYLE 26 PIN 1. 2. 3.	V <sub>CC</sub>
2.	GATE DRAIN SOURCE

STYLE 2: PIN 1. BASE 2. EMITTER 3. COLLECTOR STYLE 7: PIN 1. SOURCE 2. DRAIN 3. GATE STYLE 12: PIN 1. MAIN TERMINAL 1 2. GATE 3. MAIN TERMINAL 2 STYLE 17: PIN 1. COLLECTOR 2. BASE 3. EMITTER STYLE 22: PIN 1. SOURCE 2. GATE 3. DRAIN STYLE 27: PIN 1. MT 2. SUBSTRATE 3. MT STYLE 32 PIN 1. BASE 2. COLLECTOR 3. EMITTER

Style Pin	1. 2.	ANODE ANODE CATHODE
STYLE PIN	1. 2.	DRAIN GATE SOURCE & SUBSTRATE
STYLE PIN	1. 2.	ANODE 1 GATE CATHODE 2
STYLE PIN	1. 2.	ANODE CATHODE NOT CONNECTED
Style Pin	1. 2.	GATE SOURCE DRAIN
Style Pin	1. 2.	CATHODE ANODE GATE
STYLE PIN	1. 2.	RETURN INPUT OUTPUT

STYLE 4: PIN 1. CATHODE 2. CATHODE 3. ANODE STYLE 9: PIN 1. BASE 1 2. EMITTER 3. BASE 2 STYLE 14: PIN 1. EMITTER 2. COLLECTOR 3. BASE STYLE 19: PIN 1. GATE 2. ANODE 3. CATHODE STYLE 24: PIN 1. EMITTER 2. COLLECTOR/ANODE 3. CATHODE STYLE 29: PIN 1. NOT CONNECTED 2. ANODE 3. CATHODE STYLE 34:

PIN 1. INPUT

2. GROUND 3. LOGIC

2. SOURCE 3. GATE STYLE 10: PIN 1. CATHODE 2. GATE 3. ANODE STYLE 15: PIN 1. ANODE 1 2. CATHODE 3. ANODE 2 STYLE 20: PIN 1. NOT CONNECTED 2. CATHODE 3. ANODE STYLE 25: PIN 1. MT 1 2. GATE 3. MT 2 STYLE 30: PIN 1. DRAIN 2. GATE 3. SOURCE STYLE 35: PIN 1. GATE 2. COLLECTOR 3. EMITTER

#### GENERIC MARKING DIAGRAM\*

XXXXX XXXXX ALYW

XXXX = Specific Device Code

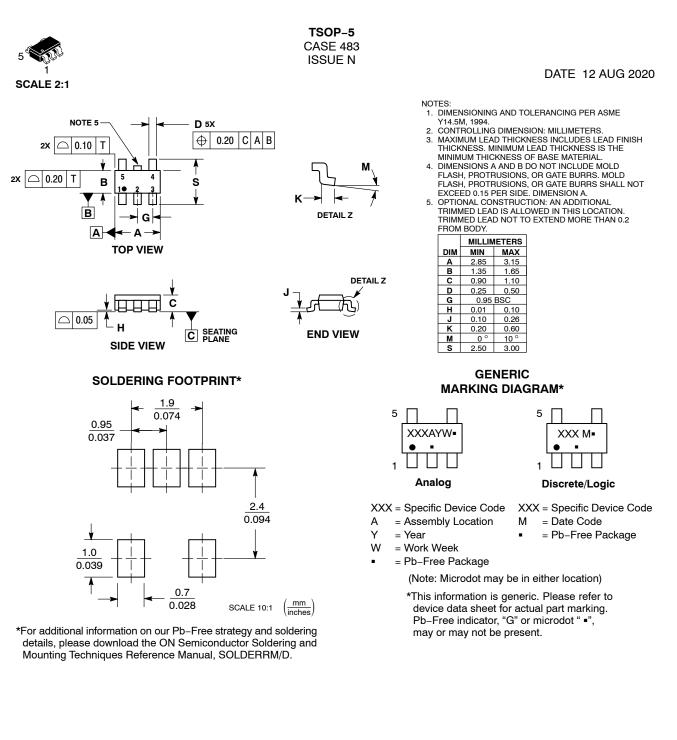
- A = Assembly Location
- L = Wafer Lot
- Y = Year
- W = Work Week
  - = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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#### SOIC-8 NB CASE 751-07 ISSUE AK

STYLE 1: PIN 1. EMITTER COLLECTOR 2. 3. COLLECTOR 4. EMITTER 5. EMITTER BASE 6. 7 BASE EMITTER 8. STYLE 5: PIN 1. DRAIN 2. DRAIN 3. DRAIN DRAIN 4. GATE 5. 6. GATE SOURCE 7. 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON COLLECTOR, DIE #1 COLLECTOR, DIE #2 2. З. EMITTER, COMMON 4. 5. EMITTER, COMMON 6 BASE. DIE #2 BASE, DIE #1 7. 8 EMITTER, COMMON STYLE 13: PIN 1. N.C. 2. SOURCE 3 GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. DRAIN 8. STYLE 17: PIN 1. VCC 2. V2OUT V10UT З. TXE 4. 5. RXE 6. VFF 7. GND 8. ACC STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 3 CATHODE 3 CATHODE 4 4. 5. CATHODE 5 6. COMMON ANODE COMMON ANODE 7. CATHODE 6 8. STYLE 25: PIN 1. VIN 2 N/C REXT З. 4. GND 5. IOUT IOUT 6. IOUT 7. 8. IOUT STYLE 29: BASE, DIE #1 PIN 1. 2 EMITTER, #1 BASE, #2 З. EMITTER, #2 4. 5 COLLECTOR, #2 COLLECTOR, #2 6.

STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 COLLECTOR, #2 3. COLLECTOR, #2 4 BASE, #2 5. EMITTER, #2 6. 7 BASE #1 EMITTER, #1 8. STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN SOURCE 4. SOURCE 5. 6. GATE GATE 7. 8. SOURCE STYLE 10: GROUND PIN 1. BIAS 1 OUTPUT 2. З. GROUND 4. 5. GROUND 6 BIAS 2 INPUT 7. 8. GROUND STYLE 14: N-SOURCE PIN 1. 2. N-GATE 3 P-SOURCE P-GATE 4. P-DRAIN 5 6. P-DRAIN N-DRAIN 7. N-DRAIN 8. STYLE 18: PIN 1. ANODE ANODE 2. SOURCE 3. GATE 4. 5. DRAIN 6 DRAIN CATHODE 7. CATHODE 8. STYLE 22 PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC 3 COMMON CATHODE/VCC 4. I/O LINE 3 COMMON ANODE/GND 5. 6. I/O LINE 4 7. I/O LINE 5 8. COMMON ANODE/GND STYLE 26: PIN 1. GND 2 dv/dt З. ENABLE 4. ILIMIT 5. SOURCE SOURCE 6. SOURCE 7. 8. VCC STYLE 30: DRAIN 1 PIN 1. DRAIN 1 2 GATE 2 З. SOURCE 2 4 SOURCE 1/DRAIN 2 SOURCE 1/DRAIN 2 5. 6.

STYLE 3: DRAIN, DIE #1 PIN 1. DRAIN, #1 2. DRAIN, #2 З. DRAIN, #2 4. 5. GATE, #2 SOURCE, #2 6. 7 GATE #1 8. SOURCE, #1 STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS THIRD STAGE SOURCE GROUND З. 4. 5. DRAIN 6. GATE 3 SECOND STAGE Vd 7. FIRST STAGE Vd 8. STYLE 11: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. З. GATE 2 4. 5. DRAIN 2 6. DRAIN 2 DRAIN 1 7. 8. DRAIN 1 STYLE 15: PIN 1. ANODE 1 2. ANODE 1 3 ANODE 1 ANODE 1 4. 5. CATHODE, COMMON CATHODE, COMMON CATHODE, COMMON 6. 7. CATHODE, COMMON 8. STYLE 19: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 8. **MIRROR 1** STYLE 23: PIN 1. LINE 1 IN COMMON ANODE/GND COMMON ANODE/GND 2. 3 LINE 2 IN 4. LINE 2 OUT 5. COMMON ANODE/GND COMMON ANODE/GND 6. 7. 8. LINE 1 OUT STYLE 27: PIN 1. ILIMIT OVI O 2 З. UVLO 4. INPUT+ 5. 6. SOURCE SOURCE SOURCE 7. 8 DRAIN

## DATE 16 FEB 2011

STYLE 4: PIN 1. 2. ANODE ANODE ANODE З. 4. ANODE ANODE 5. 6. ANODE 7 ANODE COMMON CATHODE 8. STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 З. BASE #2 COLLECTOR, #2 4. COLLECTOR, #2 5. 6. EMITTER, #2 EMITTER, #1 7. 8. COLLECTOR, #1 STYLE 12: PIN 1. S SOURCE SOURCE 2. 3. GATE 4. 5. DRAIN 6 DRAIN DRAIN 7. 8. DRAIN STYLE 16 EMITTER, DIE #1 PIN 1. 2. BASE, DIE #1 EMITTER DIE #2 3 BASE, DIE #2 4. 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 COLLECTOR, DIE #1 7. COLLECTOR, DIE #1 8. STYLE 20: PIN 1. SOURCE (N) GATE (N) SOURCE (P) 2. 3. 4. GATE (P) 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 24: PIN 1. BASE EMITTER 2. 3 COLLECTOR/ANODE COLLECTOR/ANODE 4. 5. CATHODE 6. CATHODE COLLECTOR/ANODE 7. COLLECTOR/ANODE 8. STYLE 28: 11. SW\_TO\_GND 2. DASIC OFF PIN 1. DASIC\_SW\_DET З. 4. GND 5. 6. V MON VBULK 7. VBULK 8 VIN

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SOURCE 1/DRAIN 2

7.

8. GATE 1

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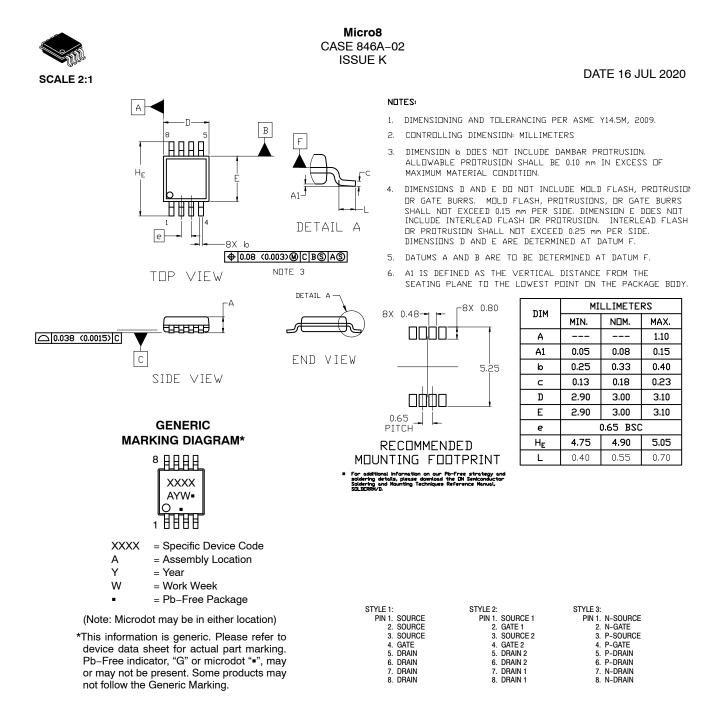
7.

8

COLLECTOR, #1

COLLECTOR, #1





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